

From: hpmcuong@hcmut.edu.vn <hpmcuong=hcmut.edu.vn@edas.info>
Date: Fri, Sep 27, 2019 at 9:47 AM
Subject: [ISEE2019] Your paper #1570570299
(Landslide Detection Method Using Laser Beam')
To: Florentinus Budi Setiawan <fbudis70@gmail.com>, Maria Wahyuni
<maria.wahyuni@gmail.com>, Suyanto Antonius
<suyantoantonius@gmail.com>

Dear authors:

ISEE 2019 would ask you please, on the EDAS system:

1/ Register your attendance (you can pay by cash onsite)

2/ Submit Copyright form

so that your paper can be presented and published on IEEE explore.

Thank you for your cooperation.

Regards,

ISEE2019 Technical Program Chairs

From: hpmcuong@hcmut.edu.vn <hpmcuong=hcmut.edu.vn@edas.info>
Date: Sun, Sep 29, 2019 at 6:07 AM
Subject: [ISEE2019] Your paper #1570570299
(Landslide Detection Method Using Laser Beam')
To: Florentinus Budi Setiawan <fbudis70@gmail.com>, Maria Wahyuni
<maria.wahyuni@gmail.com>, Suyanto Antonius
<suyantoantonius@gmail.com>
Cc: <hpmcuong@hcmut.edu.vn>

Dear Dr. Florentinus Budi Setiawan,

ISEE 2019 is making its program and would hear from you about if you are interesting in presenting your accepted paper. Please let us know so that we can organize well the ISEE 2019.

If we do not hear from you by tomorrow noon, the your paper will be withdrawn from the ISEE2019 based on its regulation.

Thank you.

Regards,

ISEE2019 Technical Program Chairs

ari: <ecopyright@ieee.org>

Tanggal: 29 Sep 2019 10:53 AM

Subjek: IEEE Copyright Transfer Confirmation for

Article: Landslide Detection Method Using Laser Beam

Kepada: <fbudis70@gmail.com>

Cc: <maria.wahyuni@gmail.com>, <suyantoantonius@gmail.com>

IEEE Electronic Publication Agreement Receipt

=====

Publication Title: 2019 International Symposium on Electrical and Electronics Engineering (ISEE)

Article Title: Landslide Detection Method Using Laser Beam

Author(s): Dr. Florentinus Budi Setiawan, Mrs. Maria Wahyuni and Mr. Suyanto Edward Antonius

Author E-

mail: fbudis70@gmail.com, maria.wahyuni@gmail.com, suyantoantonius@gmail.com

eCF Paper Id: 1570570299

Dear Colleague

Congratulations! You have successfully completed the IEEE Electronic Publication Agreement. A copy of the fully executed Agreement is attached here for your records. Please save this e-mail for any future reference.

PLEASE DO NOT RESPOND TO THIS EMAIL.

For technical assistance or to search our knowledge base, please visit our support site at :

<http://iee.custhelp.com/app/answers/list/p/197,2375>